

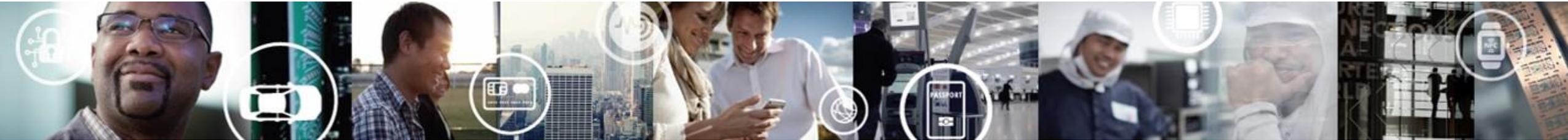
# S32K1 PRODUCTS AND SOLUTIONS UPDATE

VINCENT DENG / 邓尚超

汽车微控制器和处理器产品市场经理

SEPT 2019

## AUTOMOTIVE MICROCONTROLLERS & PROCESSORS



EXTERNAL USE



SECURE CONNECTIONS  
FOR A SMARTER WORLD

# Contents

- S32K1 MCUs
  - Overview
  - MCU Families
  - Hot PNs
  - Roadmap
  - Success Stories
- S32K1 Demos
- Touch Sense Solution
- ISELED LED Lighting Kit
- Automotive NFC Stack
- 3<sup>rd</sup> party tools



# S32K1 MCUS



# S32K Target Apps: Truly General Purpose

## Body Electronics



HVAC



Steering wheel



Lighting



Battery/Power mgmt



Doors



Body Controllers

## Motor Control



Engine /  
cooling fans



Wipers



Window lift



Diesel / Oil Pump

## Chassis/Safety



TPMS



Suspensions

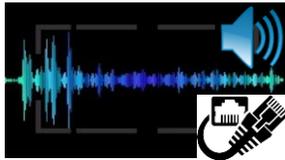


Gear shifter



Motorcycle ABS

## Infotainment

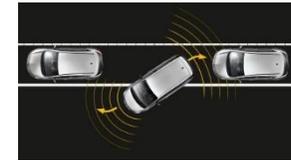


Eth. Audio Amp



Wireless Charging,  
NFC pairing

## ADAS



Park Assist



Motorized cameras

# Why is S32K1xx Successful?

## ✓ Where we win:

- Lighting
- HVAC and Steering Angle
- Gear Shifter
- I/O Controllers
- Sunroof
- Power Opening Tailgate
- BMS
- Wireless Charging

## ✓ Why we win:

- Family/platform compatibility
- CSEc for secure boot
- ASIL capability
- Ease-of-use



# S32K1 Family – Accelerating Automotive Software Design

## Performance & Integration

### Future proof designs

- ARM Cortex M4F and M0+ cores
- ISO CAN-FD, CSEc hardware security, ISO26262 ASIL-B functional safety
- Ultra low power



## Automotive-grade SW

### Minimized complexity

- S32 Design Studio IDE
- Automotive-grade Software Development Kit (SDK)
- Autosar MCAL & OS, 3<sup>rd</sup> party ecosystem



## Broad Portfolio

### Maximised reuse

- 128KB to 2MB, 32 to 176 pins
- H/w and S/w compatibility
- AEC Q100 grade 1 qualified (125°C), min. 15 year longevity



Product Longevity



# S32K14x and S32K11x Features

Production

S32K11x

S32K116

S32K118

Arm Cortex-M0+ @ 48MHz

128KB Flash

256KB Flash

16KB SRAM

24KB SRAM

up to 42 I/Os

up to 58 I/Os

4 channel eDMA

1x FlexCAN with 1x FD

1x 13-ch 12-bit ADC

1x 16-ch 12-bit ADC

QFN-32

LQFP-64

LQFP-48

Common Features

AEC-Q100, 125°C, 5V

CSEc Security Module

Low Power Operating Modes & Peripherals

ASIL-B Capable: (ECC, MPU, CRC, W'DOGs)

LPUART, LPSPI, LPIIC, FlexIO

FlexTimers, LP Timers, Prog. Delay Block

8-40MHz Ext. Osc, 8/48MHz Osc., 128KHz LPO

\*JTAG

S32DS IDE, SDK

Autosar MCAL / OS

Application SW

S32K142

S32K144

S32K146

S32K148

Arm Cortex-M4F @ up to 112MHz

256KB Flash

512KB Flash

1MB Flash

2MB Flash

32KB SRAM

64KB SRAM

128KB SRAM

256KB SRAM

up to 89 I/Os

up to 128 I/Os

up to 156 I/Os

16 channel eDMA

2x FlexCAN with 1x FD\*\*

3x FlexCAN with 1x FD\*\*

3x FlexCAN with 2x FD

3x FlexCAN with 3x FD

2x 16-ch 12-bit ADC

2x 24-ch 12-bit ADC

2x 32-ch 12-bit ADC

LQFP-64

LQFP-176

LQFP-48

LQFP-144

LQFP-100

LQFP-100

MAPBGA-100

IEEE 1588 ENET

Quad SPI

ETM Trace

2x SAI

S32K14x



# S32K1xx Feature Comparison Table

		K116	K118	K142	K144	K146	K148
<b>Memory</b>	Flash	128KB	256KB	256KB	512KB	1MB	2MB
	ECC	Yes	Yes	Yes	Yes	Yes	Yes
	SRAM (inc. FlexRAM and MTB)	17KB	25KB	32KB	64KB	128KB	256KB
	FlexRAM	2KB		4KB			
	Cache	NA		4KB			
	EEPROM emulated by FlexRAM	2KB (up to 32KB D-Flash)		4KB (up to 64 KB D-Flash)			4 KB*
	External memory interface	NA		NA			QSPI
<b>Timer</b>	Low Power Interrupt Timer	1	1	1	1	1	1
	FlexTimer (8 channels, 16-bit counter)	2	2	4	4	6	8
	Low Power Timer	1	1	1	1	1	1
	Real Time Counter	1	1	1	1	1	1
	Programmable Delay Block	1	1	2	2	2	2
<b>Analog</b>	Trigger Mux	1 × 43	1 × 45	1 × 64	1 × 64	1 × 73	1 × 81
	12-bit SAR ADC (1 Msps each)	1 × 13	1 × 16	2 × 16	2 × 16	2 × 24	2 × 32
	Comparator with 8-bit DAC	1		1			
<b>Communication</b>	10/100 Mbps IEEE-1588 ENET MAC	NA		NA			1
	Serial Audio Interfance (AC97, TDM, I2S)	NA		NA			2
	Low Power UART/LIN	2	2	2	3	3	3
	Low Powe I2C	1	1	1	1	1	2
	FlexCAN (with CAN FD)	1 (1)	1 (1)	2 (1)	3 (1)	3 (2)	3 (3)
	FlexIO ( 8 pins configurable as UART, SPI, I2C, I2S)	1	1	1	1	1	1



# S32K1 – Priority PNs

ID	Features
UA*	112 MHz, Security, CANFD, FlexIO, Max RAM
HR	80MHz, Max RAM
HA	80 MHz, Security, CANFD, FlexIO, Max RAM
HF	80MHz, CANFD, FlexIO, Max RAM
UJ*	112 MHz, ENET & Audio, Security, CANFD, FlexIO, Max RAM
HE	80 MHz, ENET & Audio , Max RAM

Pins	LQFP	QFN	BGA
32	LC	FM	-
48	LF	-	-
64	LH	-	-
100	LL	-	MH
144	LQ	-	-
176	LU	-	-

PN Tier	S32K116	S32K118	S32K142	S32K144	S32K146	S32K148
	128 KB Flash 17 KB RAM	256 KB Flash 25 KB RAM	256 KB Flash 32 KB RAM	512 KB Flash 64 KB RAM	1 MB Flash 128 KB RAM	2 MB Flash 256 KB RAM
<b>Priority PRODUCTION (16)</b>	<b>48MHz, M Temp</b>	<b>48MHz, M Temp</b>	<b>80MHz, M Temp</b>	<b>80MHz, M Temp</b>	<b>80MHz, M Temp</b>	<b>112MHz, V Temp</b>
	FS32K116LAT0MLFT	FS32K118LAT0MLHT	FS32K142HAT0MLHT	FS32K144HAT0MLHT	FS32K146HAT0MLLT	FS32K148UJT0VLUT
	FS32K116LAT0MFMT	FS32K118LAT0MLFT	FS32K142HAT0MLLT	FS32K144HAT0MLLT	FS32K146HAT0MLQT	FS32K148UJT0VLQT
				FS32K144HAT0MMHT	FS32K146HAT0MLHT	FS32K148UJT0VMHT
					FS32K146HAT0MMHT	
				<b>112MHz, V Temp</b>	<b>112MHz, V Temp</b>	<b>112MHz, V Temp</b>
<b>Priority SAMPLE (15)</b>			FS32K142UAT0VLLT	FS32K144UAT0VLLT	FS32K146UAT0VLLT	FS32K148HAT0MLQT
			FS32K142UAT0VLHT	FS32K144UAT0VMHT	FS32K146UAT0VLQT	FS32K148HAT0MLUT
				FS32K144UAT0VLHT	FS32K146UAT0VLHT	FS32K148HAT0MMHT
					FS32K146UAT0VMHT	FS32K148HET0MLQT
						FS32K148HET0MLUT
						FS32K148HET0MMHT

\*For PN 9 & 10<sup>th</sup> character = UA or UJ: Write or erase access to security (CSEc) or EEPROM is allowed only when device operating in RUN mode (up to 80MHz). No write or erase access to security and EEPROM allowed when device running at HSRUN mode (112MHz).

# S32K1 / KEA Product Series Compatibility

## Pin Compatibility: ✓

- Within S32K1xx product series
- Similar pinout as KEA products

## IP Compatibility: ✓

- With MPC55xx/MPC56xxx/MPC57xxx product series: FlexCAN, ACMP, eDMA, QuadSPI
- With KEA products: FlexTimer, IIC, LSPI, UART, CRC, FlexIO

Flash	Package									
	16TSSOP	24QFN	32QFN	48LQFP	64LQFP	80LQFP	100 LQFP	100 BGA	144LQFP	176LQF
	4.4 x 5 mm, (0.65 mm pitch)	4 x 4 mm, (0.5 mm pitch)	5 x 5 mm, (0.5 mm pitch)	7 x 7 mm, (0.5 mm pitch)	10 x 10 mm, (0.5 mm pitch)	14 x 14 mm, (0.65 mm pitch)	14 x 14 mm, (0.5 mm pitch)	11 x 11 mm, (1 mm pitch)	20 x 20 mm, (0.5 mm pitch)	24 x 24 mm, (0.5 mm pitch)
2M							<b>S32K148</b>	<b>S32K148</b>	<b>S32K148</b>	<b>S32K148</b>
1M					<b>S32K146</b>		<b>S32K146</b>	<b>S32K146</b>	<b>S32K146</b>	
512K				<b>S32K144</b> <b>S32K144W</b>	<b>S32K144</b> <b>S32K144W</b>		<b>S32K144</b>	<b>S32K144</b>		
256K				<b>S32K142</b> <b>S32K142W</b> <b>S32K118</b>	<b>S32K142</b> <b>S32K142W</b> <b>S32K118</b>		<b>S32K142</b>			
128K			<b>S32K116</b>	<b>S32K116</b>	KEAZ128	KEA128				
64K			KEAZN64		KEAZ(N)64	KEAZ64				
32K			KEAZN32		KEAZN32					
16K			KEAZN16		KEAZN16					
8K	<b>KEAZN8</b>									



# S32K1 Enablement

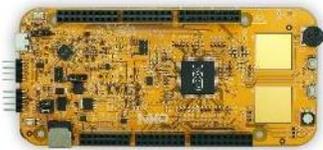
## Hardware



K148 EVB



K146 EVB



K144 EVB



K142 EVB

- S32K148EVB-Q176 (2MB) \$149
- S32K146EVB-Q144 (1MB) \$149
- S32K144EVB-Q100 (512KB) \$49
- S32K142EVB-Q100 (256KB) \$49
- NXP & 3<sup>rd</sup> party SW tool compatible, out-of-box examples for fast start-up & prototyping with [FreeMASTER tool](#)
- Arduino UNO compatible with expansion “shield” support

## Software



- *Free* S32 Design Studio IDE – Eclipse based, multiple compiler & debugger options, Processor Expert GUI tool
- *Free* S32 SDK – Production grade, low-level drivers, TCP/IP / LIN / ANFC / AVB Stacks, Touch Sense lib, SBC & ISELED drivers
- Automotive Math, Motor Control Libs., MATLAB Model Based Design Tool, Core/Peripheral Self Test Libraries

## Ecosystem

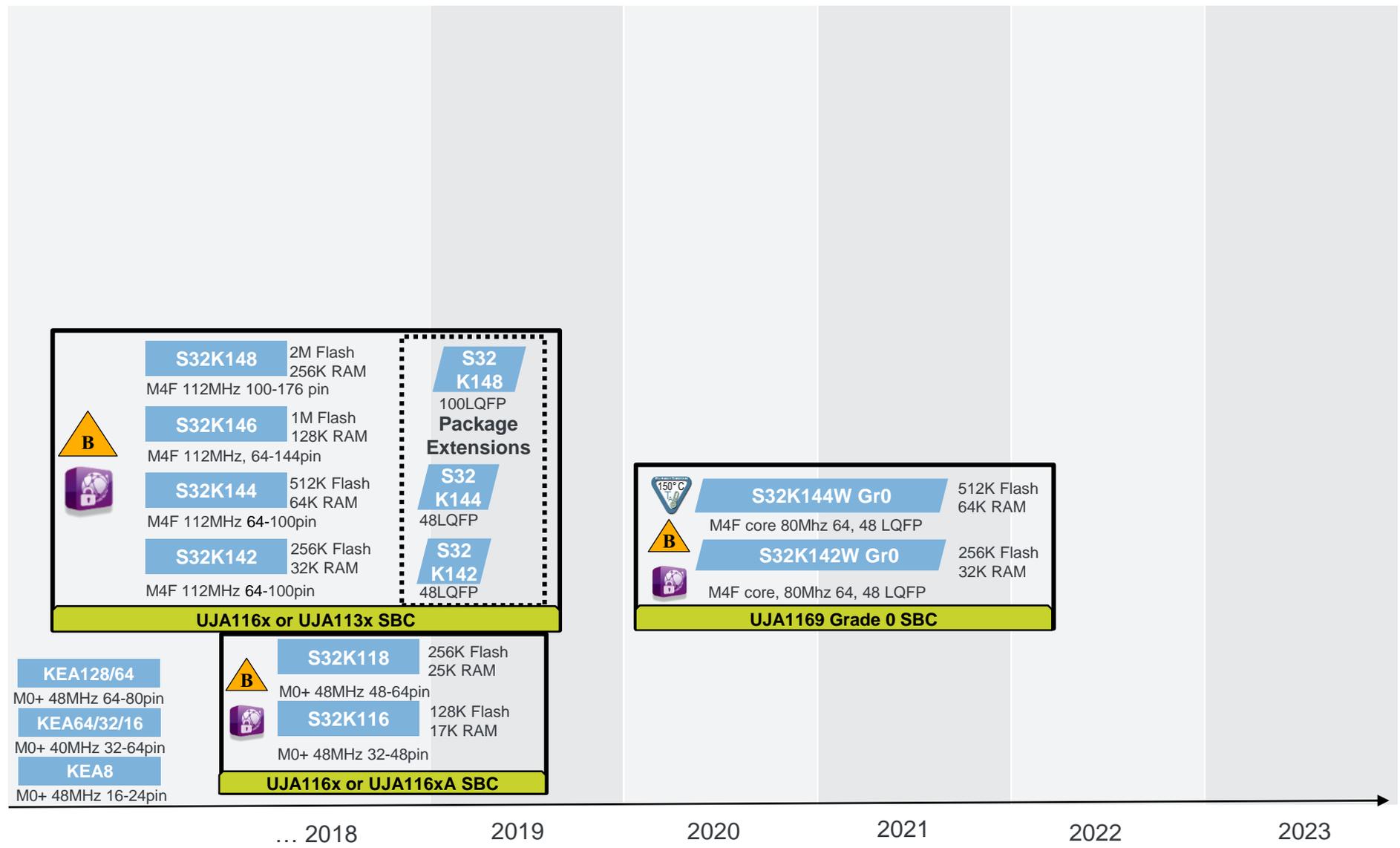


- Premium level IDE, compiler & debugger tools
- NXP & 3<sup>rd</sup> party MCAL / AUTOSAR. New ARCCORE Starter Kit (60-day evaluation license)
- S32K, S32DS & SDK Communities <http://www.nxp.com/community>



# S32K Roadmap

**S32K3 Roadmap Under DNA**



ASIL Level



CSEc Security



HSE Security

Product Idea

Concept

Development

Production

First Sample Date (left edge)

Product Qualification (right edge)



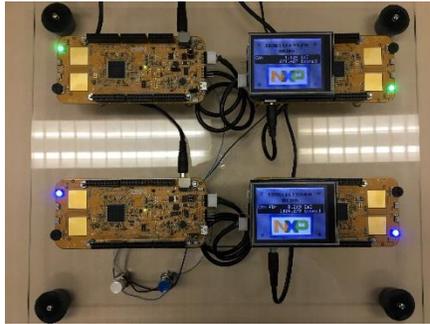
# S32K1 DEMOS



# S32K Demos



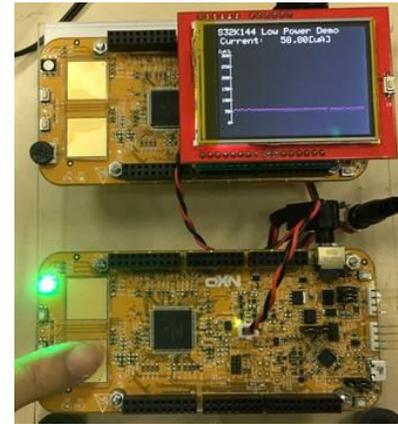
Secure CAN-FD Diagnostics  
S32K144, UJA1169



CAN-FD vs. CAN  
S32K144



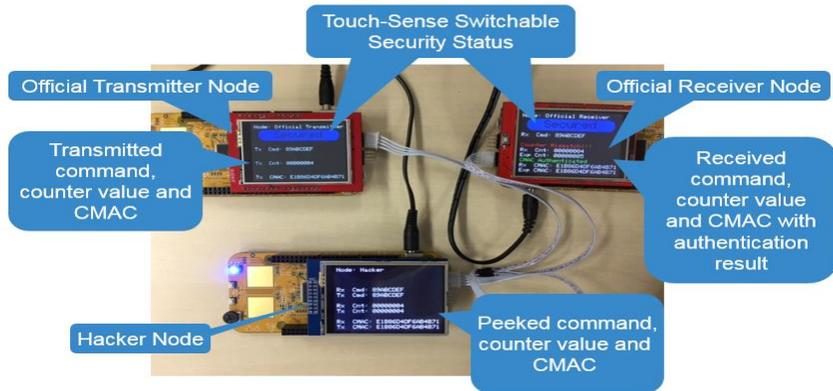
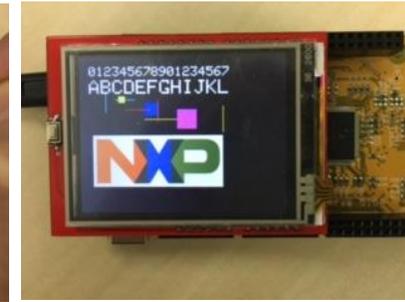
CSEc Image Decryption  
S32K144



Low Power Touch Sense  
S32K144



LCD Touchscreen  
S32K144



CAN Message Authentication  
S32K144



FlexIO - emulate UART/SPI/IIS  
S32K144



Low Power  
S32K144 +  
FreeMASTER Tool



# S32K Demos



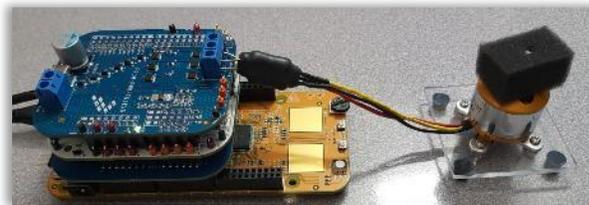
Ethernet AVB Gateway  
**S32K148**



Ethernet Camera  
+ Security  
**S32K148**



ISELED LED Lighting  
**S32K144**



BLDC Motor Control  
**S32K144 + GD3000**



DC Motor Control  
**S32K144 + HB2001**



Motorcycle ABS  
**S32K144 + SB0400**

# Touch sense demonstrator and hand off detection

- **Key Features:**

- Based on S32K144EVB Q100
- Low power consumption with build in basic EMI immunity (tested with fluorescent lamp)
- Tested with winter downhill ski gloves
- Solution based on NXP submitted patent to the United States Patent Office (one external capacitance per electrode)

- **Addressed technical challenges:**

- Sensitivity (reduced HW mutual capacitance, electrodes crosstalk compensation)
- Basic EMI immunity (ADC conversion timing, periodical electrode capacitance scanning, IIR1 LP filter)
- Low Power consumption < 60  $\mu$ A (via MCU VLPS, periodically, MCU clocked from FIRC)
- Response time < 25 ms
- Reaction time < 100 ms
- Scalability, ASIL-B



# DHRD Demonstrator

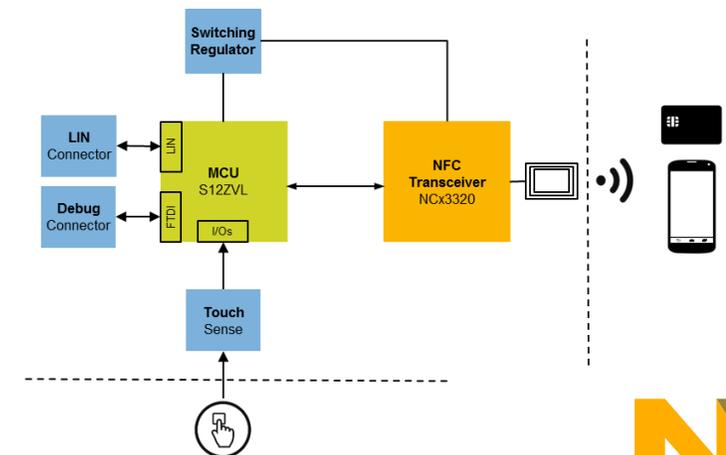
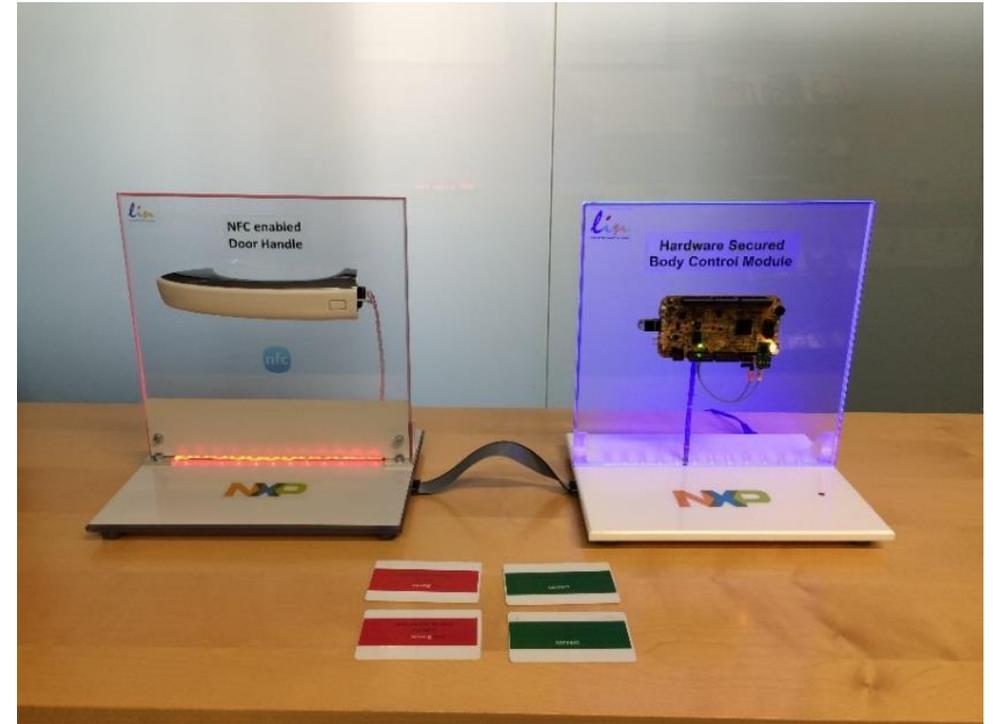
## Secure Car Access via NFC

- **Key Features:**

- Secure and smart solution for NFC car access
- DHRD embedded in real car door handle
- S12ZVL MCU based door handle module with NCx3320 NFC receiver
- **S32K** MCU based secure body control module
- Secure Element attached on body control module
- JCOP smart cards used for lock / unlock
- Smart phone with secure element used for lock / unlock

- **Addressed technical challenges:**

- Small footprint fitting to inside of door handle
- Antenna design fitting both chrome and non-chrome door handles
- Low power consumption of card detection and capacitive sensing
- ISO 26262 support



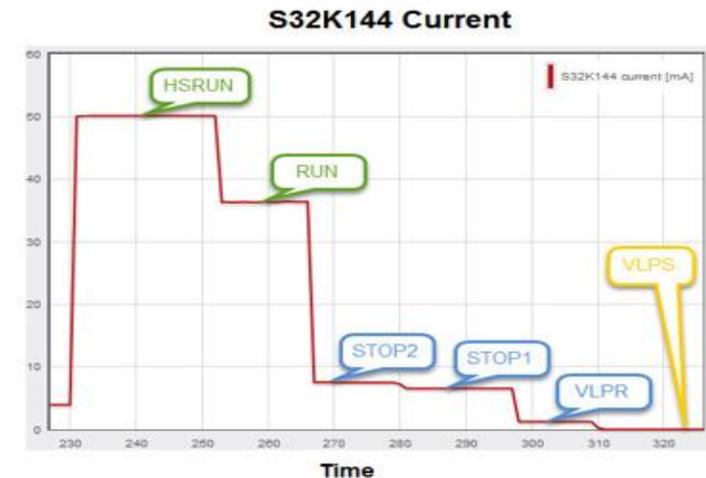
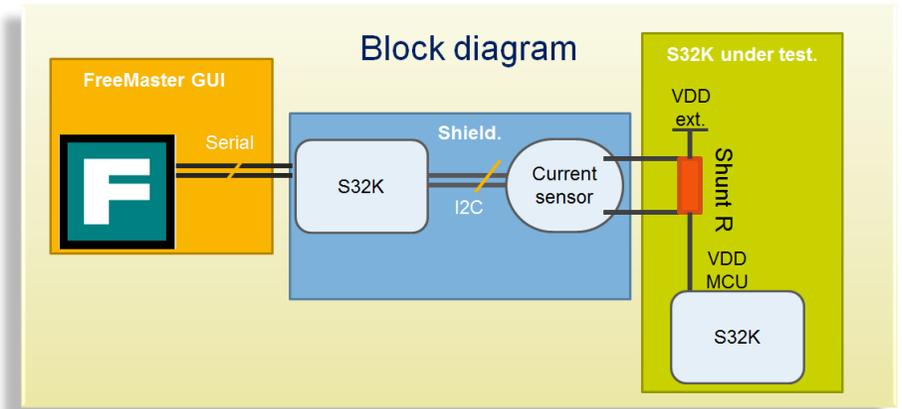
# S32K Low Power Demonstrator

## Key features:

- Demonstrating All Power modes:
  - HSRUN, RUN, STOP2, STOP1, VLPR, VLPS.
  - Showcasing application use cases.
- FreeMaster interface
- Using a “Low power S32K shield” + S32K144EVB

## Addressed technical challenges:

- <math><100\mu\text{A}</math> AVG consumption while still having periodic wakeups and ATD measurements/SCI communication
- <math><100\text{mA}</math> @HSRUN 112Mhz at peripherals enabled and working.



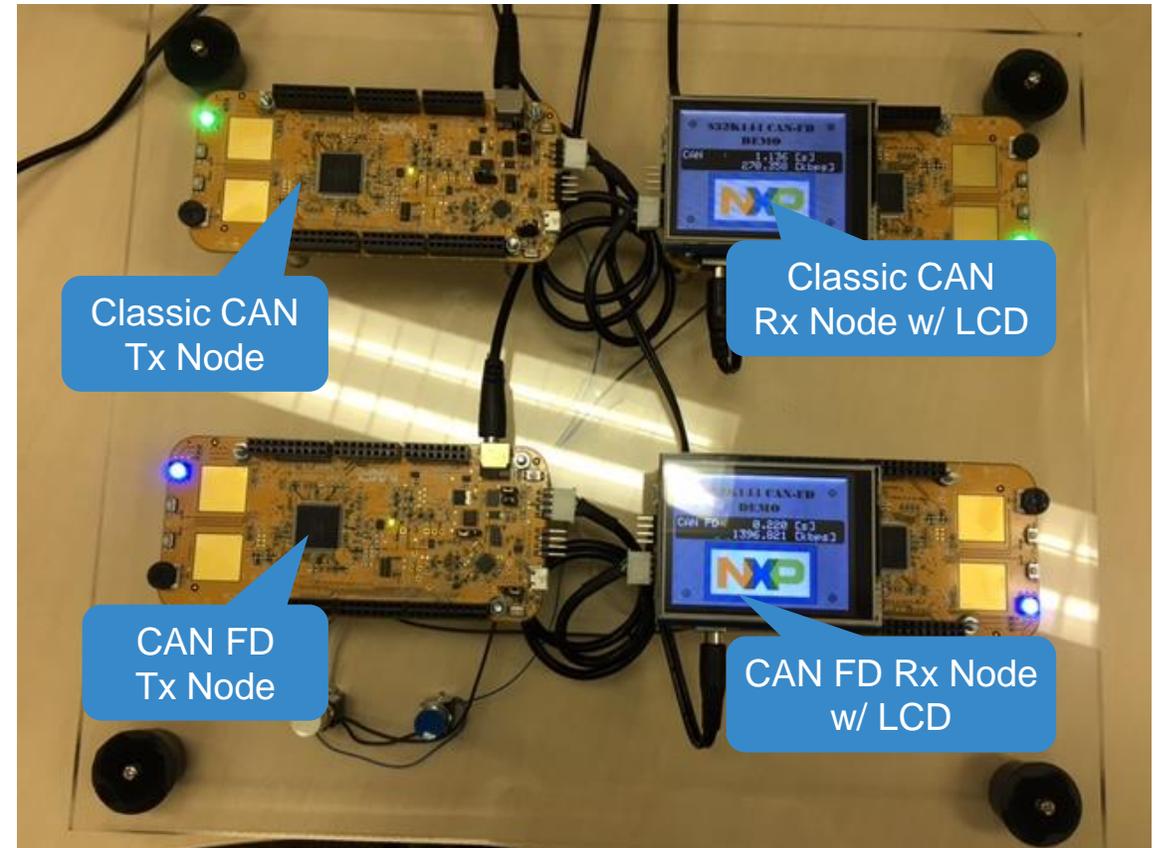
# S32K Demo – CAN-FD vs. CAN

## Overview

- Shows the performance difference between CAN message transmission using classic CAN at 500kbps with 8-byte payload vs. CAN-FD at 2Mbps with 64-byte payload
- Transmission nodes (EVBs on left-hand-side) transmit the data of NXP-logo bitmap image via a CAN interface
- Receiver nodes (EVBs on right-hand-side) receive the bitmap data and transfer to LCDs message-by-message
- **Bitmap data transmission using CAN-FD (0.2s) is much faster than classic CAN (1.1s)**

## Key Messages

- All S32K1x MCUs from 128KB to 2MB include the same ISO-certified CAN FD controller so software migration is easy throughout the family
- The CAN driver software is included free of charge in the SDK (Software Development Kit)
- S32K144EVB includes a CAN-FD compliant SBC that supports data rates up to 2Mbps



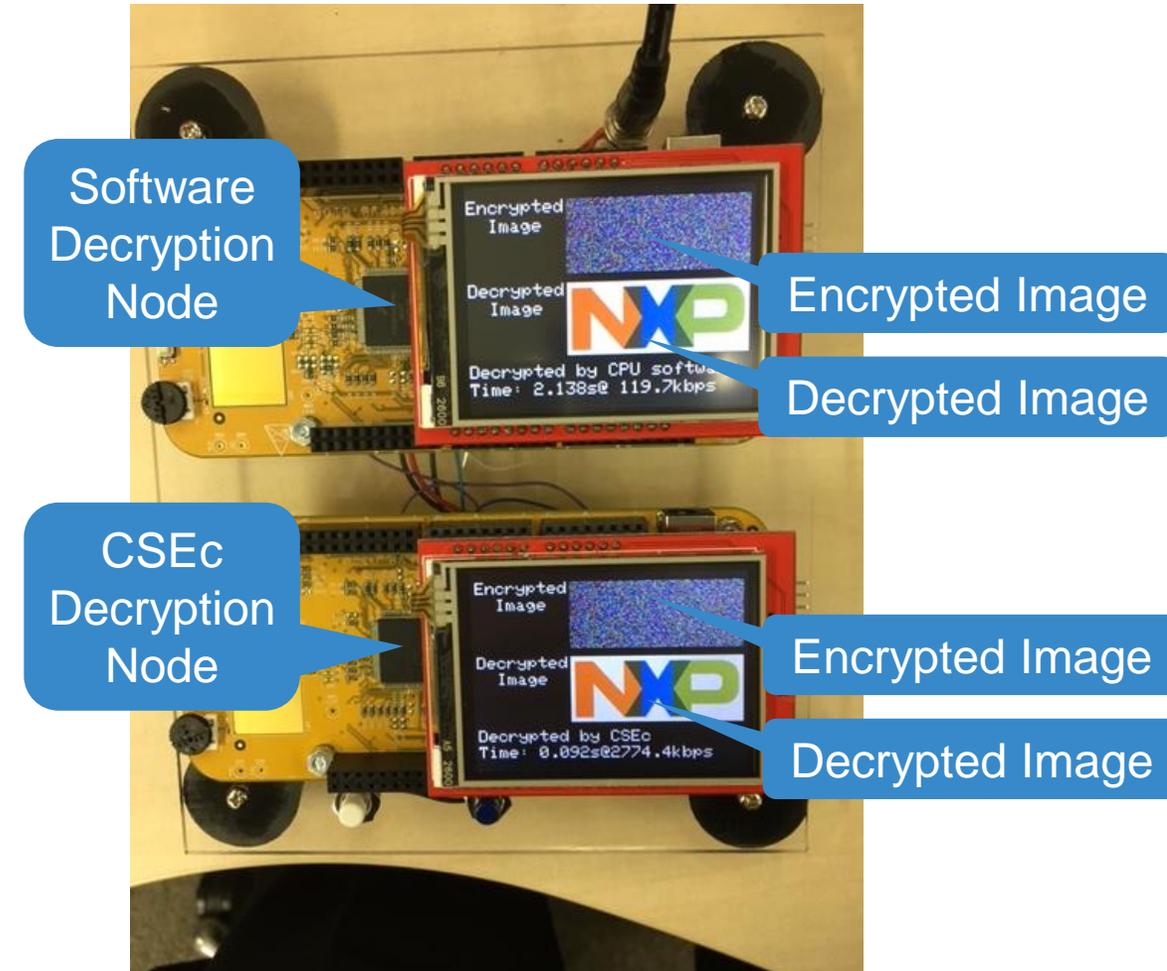
# S32K Demo – CSEc Image Decryption

## Overview

- Shows the performance (decryption speed) difference between decryption using software (core) vs. using the CSEc module with AES-128
- The NXP-logo bitmap image is pre-encrypted (CBC algorithm) and stored in the MCU memory.
- After the MCU reset, the pre-encrypted image is displayed on the upper side of LCD. The picture is not recognizable since it's encrypted.
- After pushing START button, both nodes start to decrypt the image data by 1) CPU software, and by 2) CSEc AES-128 hardware, and gradually draw the picture from top to bottom
- After the completion of entire bitmap image data decryption, elapsed time with processing data rate is displayed
- **Image decryption using CSEc (0.09s) is much faster than using software/core (2.14s)**

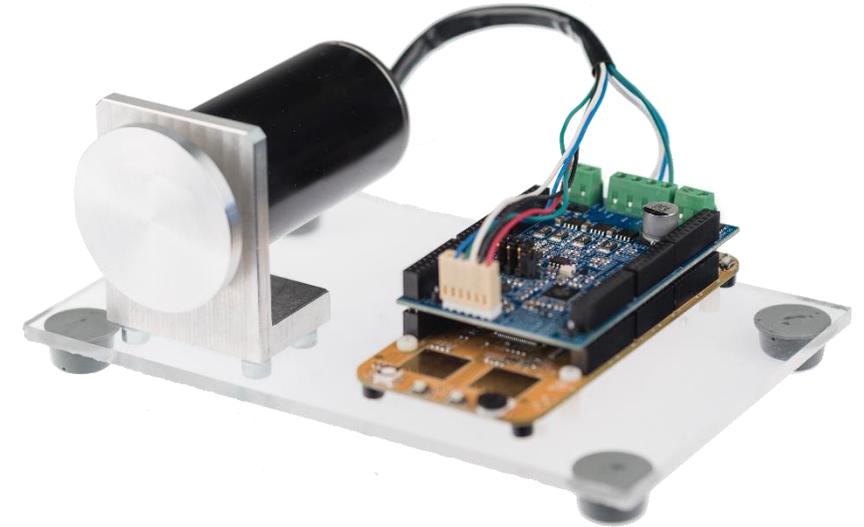
## Key Messages

- All of S32K1xx family products from 128KB to 2MB flash products include the CSEc module so migration is easy throughout the family
- The CSEc driver software is included free of charge in the SDK (Software Development Kit)



# S32K144 Based Motor Control

- **Product: MTRDEVKSBNK144 (BLDC based) & MTRDEVKSPNK144 (PMSM based)**  
(based on S32K144EVB and DEVKIT-MOTORGD)
- **Key Features:**
  - SW built on S32 EcoSys (S32 DS, S32 SDK) and MC EcoSys (AMMCLIB, FreeMASTER, MCAT)
  - Sensorbased and sensorless operation of both BLDC/PMSM motors
  - S32K key features: CAN-FD/PN, Security
- **Technical challenges addressed:**
  - Low cost reference implementation of the sensorless PMSM & BLDC control algorithms
  - Modular approach enabling additional functionality on top of MC
  - Supporting up to 24V MC applications
- **Benefits:**
  - Complete out-of-the box experience, spinning motor in 10 minutes
  - Conveniently and quickly evaluate features & performance
  - Reduce development & prototyping time
  - Faster Time to Market
- **Availability:** Q2 2017, 100pcs of BLDC & 200pcs of PMSM under manufacturing



# Automotive Math and Motor Control Library Set

## Features:

- Precompiled off-the-shelf software library containing the building blocks for a wide range of motor control applications, **significantly decreasing the development time**
- Enable **easy migration between platforms** with minimized effort
- **Production ready SW** (SPICE Level 3, CMMI and ISO9001/TS16949)
- Supporting **fixed-point 32-bit, fixed-point 16-bit** and single precision **floating point** arithmetic
- Provided with **Matlab/Simulink® models** for the control loop modeling
- Evaluation version available on [www.nxp.com/AutoMCLib](http://www.nxp.com/AutoMCLib)

## Supported Compilers:

- NXP CodeWarrrior Eclipse, NXP S32DS, GreenHills Multi, WindRiver Diab, Cosmic, IAR, GCC

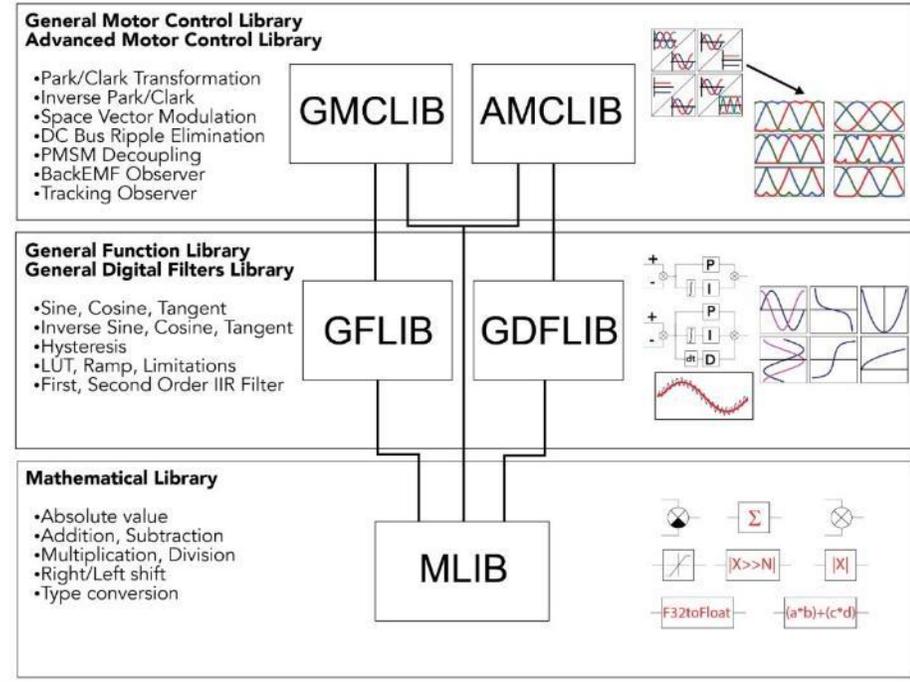
## Supported Devices:

- KEAx, S12ZVM, S32K14x
- MPC560xP, MPC560xB, MPC564xL, MPC567xF, MPC567xK
- MPC574xC, MPC574xG, MPC574xP, MPC574xR, MPC577xC, MPC577xK, MPC577xM

## Target Applications:

- Standard & advanced motor/actuator control
- Sensor based and sensor-less applications
- General mathematical applications

## Automotive Math and Motor Control Library Set



# TOUCH SENSE SOLUTION



# GPIS Touch Sense Solution



## ✓ Application focused reference design

- 7-pad keypad (S32K144 / S12ZVL)
- Steering wheel “Hands OFF detection” (S32K144)
- Offered as free of charge EMC-capable reference design

## ✓ Complete HW + SW solution

- S32K144 EVB/S12ZVL EVB
- 7-pad keypad daughter card
- S32 Design Studio
- FreeMASTER

## ✓ Future-proof MCU performance

- Functional safety – ASIL B (S32K144 / S12ZVL)
- Security HW support (S32K144)
- Flexibility to combine with multiple solutions (Motor control, Ethernet, etc)

# Availability

- Reference design package includes:
  - ✓ Installation package with S32DS project and TS application for 7-pad keypad application
  - ✓ Pin selector guide
  - ✓ User guide
  - ✓ GPIS TS Evaluation Kit
    - S32K144 EVB/S12ZVL EVB with 7-pad keypad daughter card
    - USB cable, power supply
    - Quick start guide

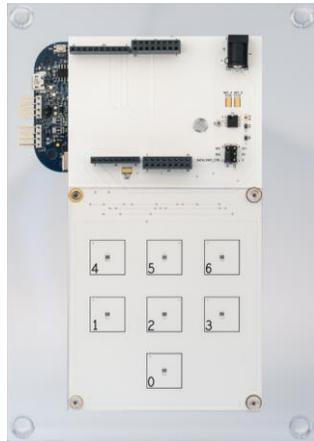
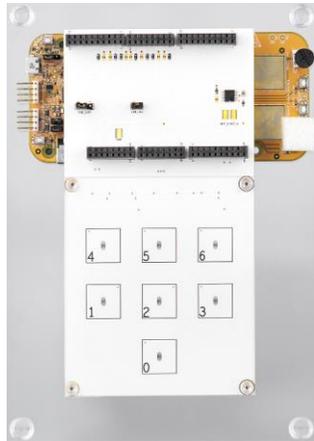
Contact [gpis.software@nxp.com](mailto:gpis.software@nxp.com) for whole reference design package



# Validation test

## 7-pad keypad (S32K144 / S12ZVL)

- Fluorescent lamp test (done)
- Phone in call test (done)
- Base EMI tests (planned, IEC 61000-4-2, ISO11452-1, etc.)
- Hand glove test (planned)
- Water drop test (planned)
- 15kV ESD (planned)



## Steering wheel “Hands OFF detection” (S32K144)

- Hand glove test (done)
- Fluorescent lamp test (done)
- Phone in call test (done)
- Base EMI tests (planned, IEC 61000-4-2, ISO11452-1, etc.)
- 15kV ESD (planned)



# ISELED LED LIGHTING KIT



# Challenges for Ambient Lighting

- Growing demand for dynamic lighting effects in the car
- Existing solutions limited in terms of number of LEDs and lighting effects. High implementation effort & cost
- Automotive requirements for robust and low emitting bus system





Open Alliance to provide complete systems solution for smart LED,  
initially targeting automotive interior lighting



- System Provider



- System Controller



- LED Manufacturer



- System Integrator



- Theoretical Framework



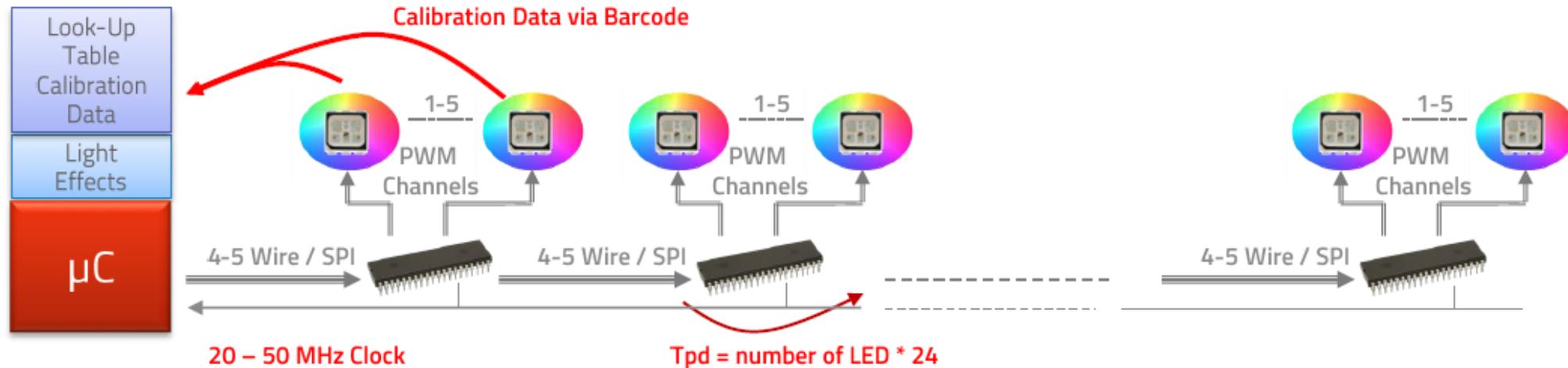
- Smart LED Driver Chip
- ISELED Concept



- Application and Lighting SW

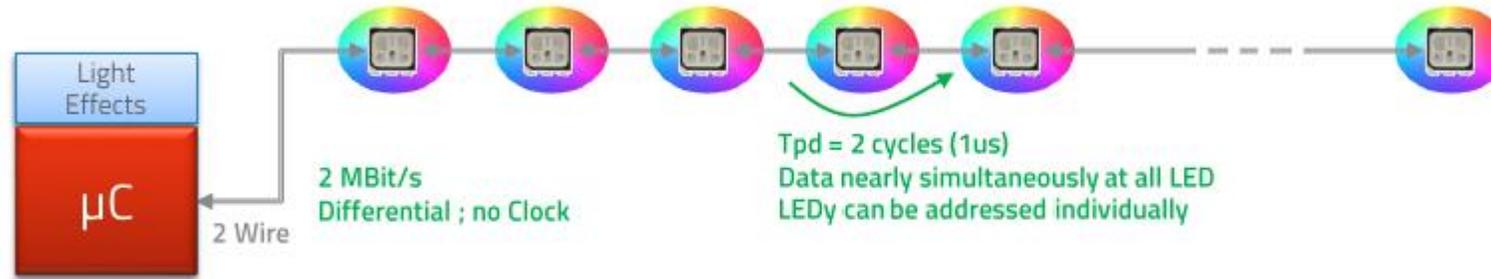


# Existing LED drive method



- Large number of ICs and wiring requirements – high cost for automotive OEM
- Calibration of each driver and LED necessary to stabilize colour and brightness over temperature and lifetime
  - Binning classes and barcoding
  - Extensive and complex s/w management
- 1-way communication to LED and sub-controllers with latencies
  - High speed single-ended communication impacting robustness
  - No diagnostics

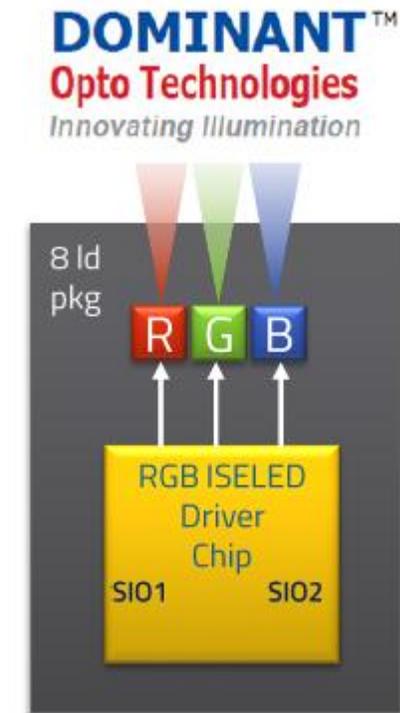
# ISELED/Smart LED drive method



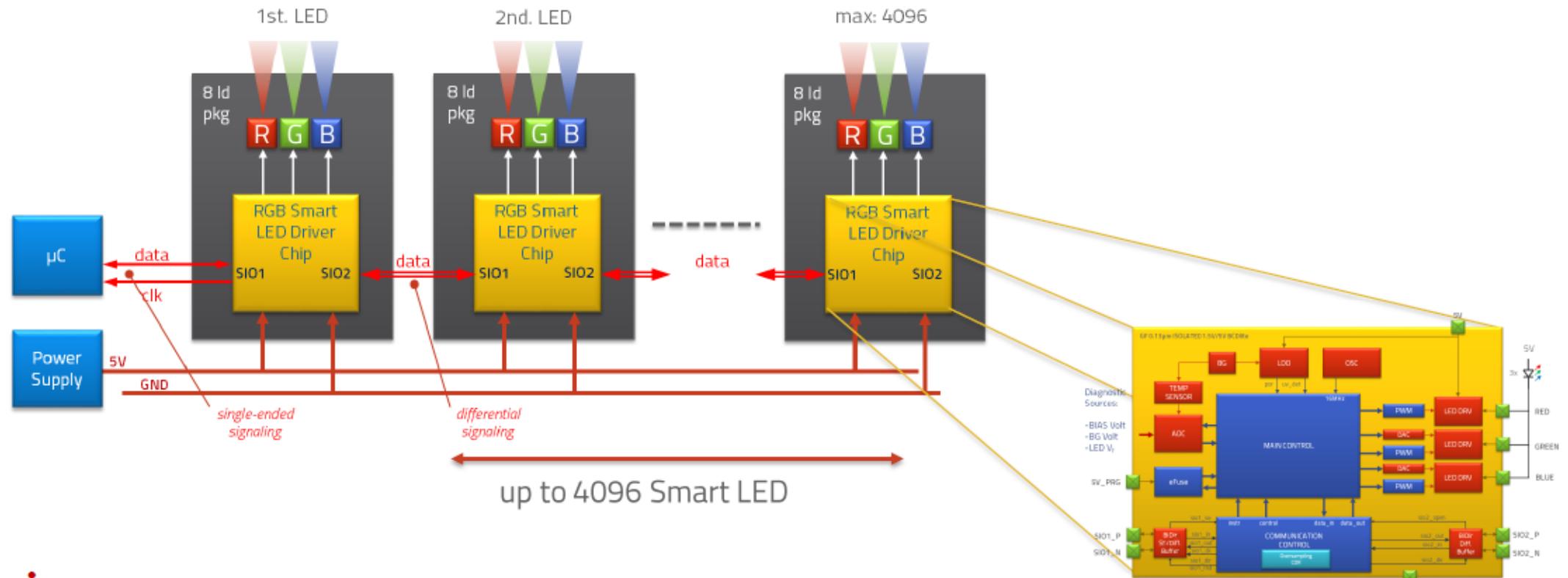
- LED module with RGB LEDs and ISELED driver chip
  - One small 3x4 mm package
  - Significant system cost reduction
- Calibration of LEDs occurs during manufacture (DWL & D65)
  - no binning classes, no bar coding – calibration data stored in Smart LED driver chip
  - system assembly using LED module from the tape with guaranteed parameters
- Bi-directional differential communication between MCU and ISELED module with lowest latencies
  - EMI robust design based on 2 Mbit/s communication - no dedicated clock
  - LED temperature and damage can be diagnosed individually by µC
  - efficient use of bandwidth due to individual addressing of each Smart LED
  - Simple RGB based colour control for up to 4096 LEDs

# ISELED Concept

- Combined package of LED and RGB ISELED driver chip
- Wavelength calibration done in fab and stored in driver chip memory
- Colour control for each LED with standard RGB value
- ISELED driver chip including:
  - Temp sensor
  - Automatic calibration & temperature compensation
  - Full-duplex, 2Mbps differential control bus
    - Up to 4096 LEDs
    - Fast update rate of 52.5uS per LED (5.25ms)
    - Read access to all LEDs
  - Bus initialisation on start-up, auto detection of new or replaced LEDs

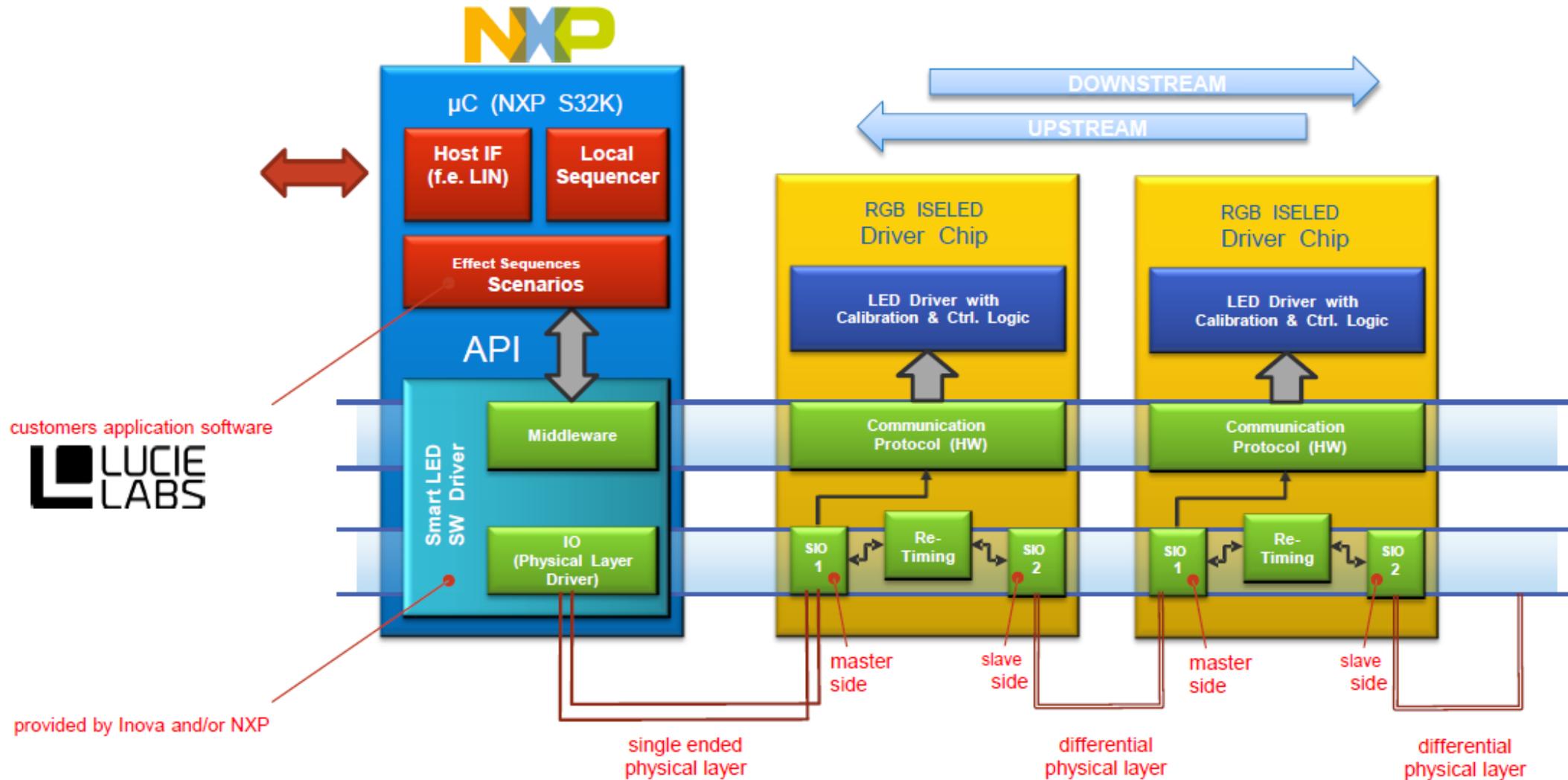


# ISELED System Concept



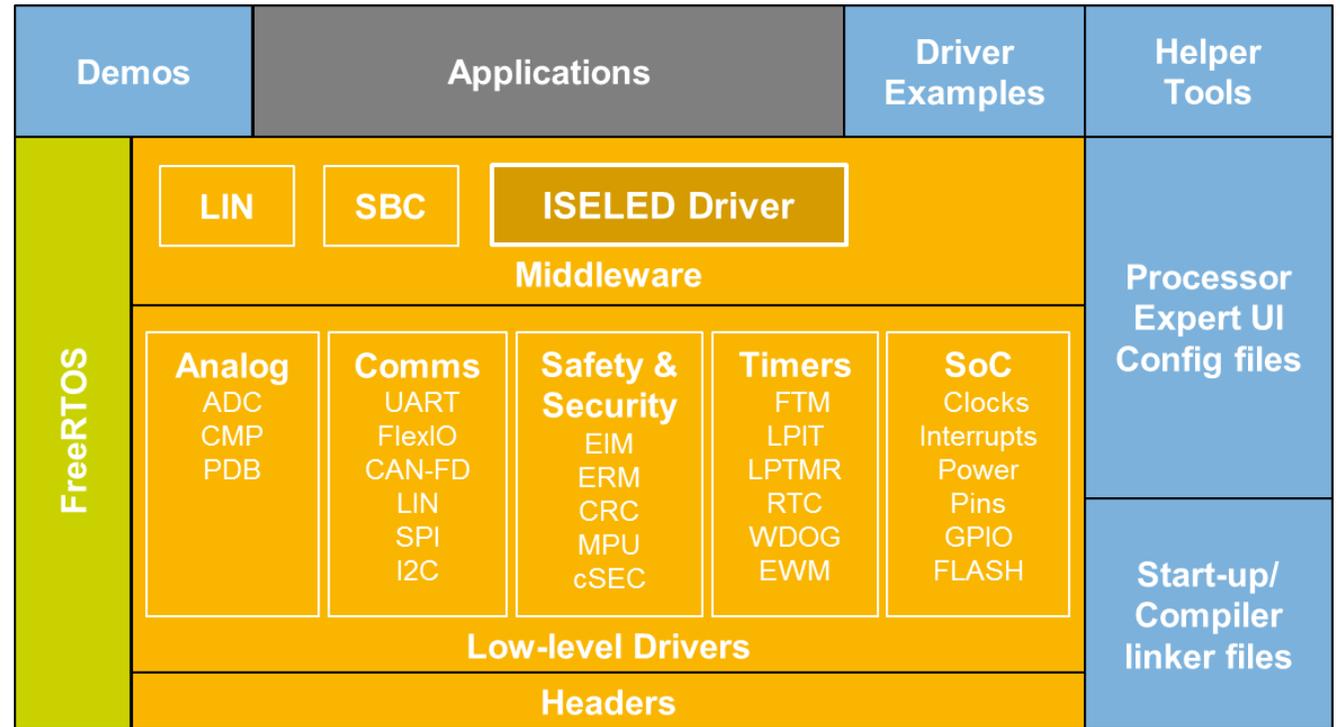
- Communication MCU to first chip is single ended (5V signalling)
- Communication between chips is differential
- Decision making during initialisation

# Application S/w – Driver & GUI



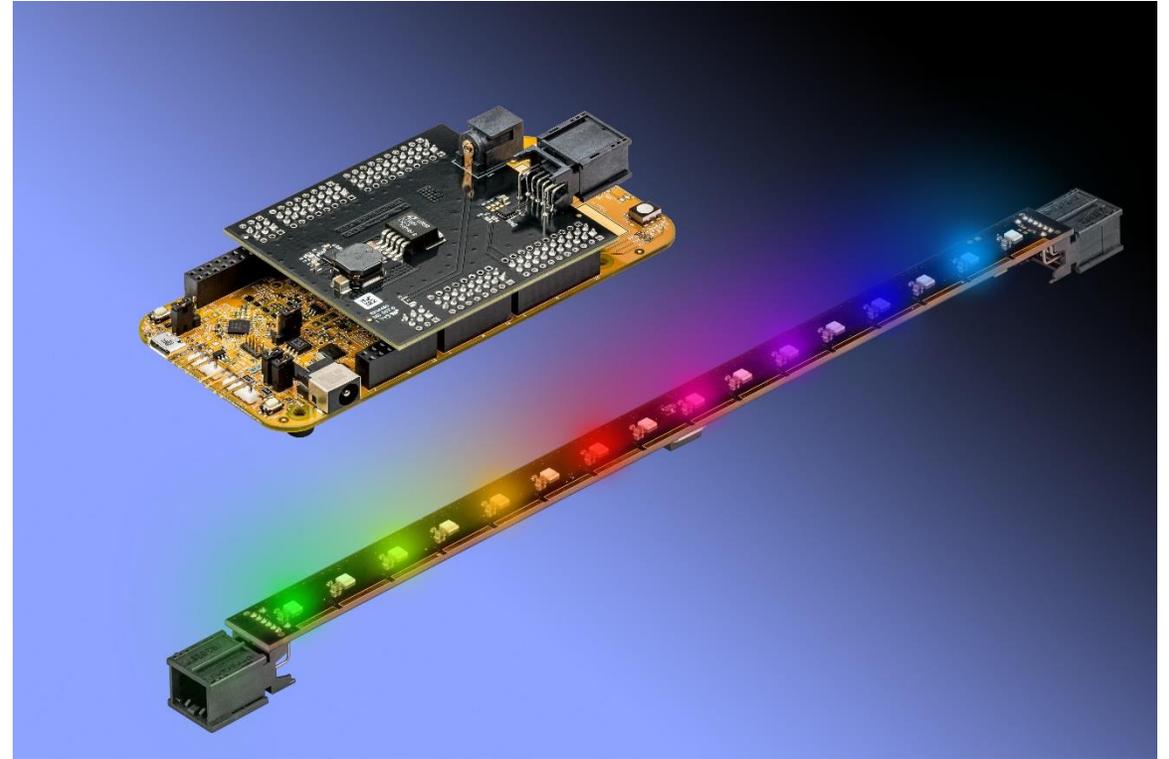
# ISELED Kit – NXP Driver

- Optional middleware for S32K SDK
- Free 90-day evaluation license



# ISELED Evaluation Kit – Hardware

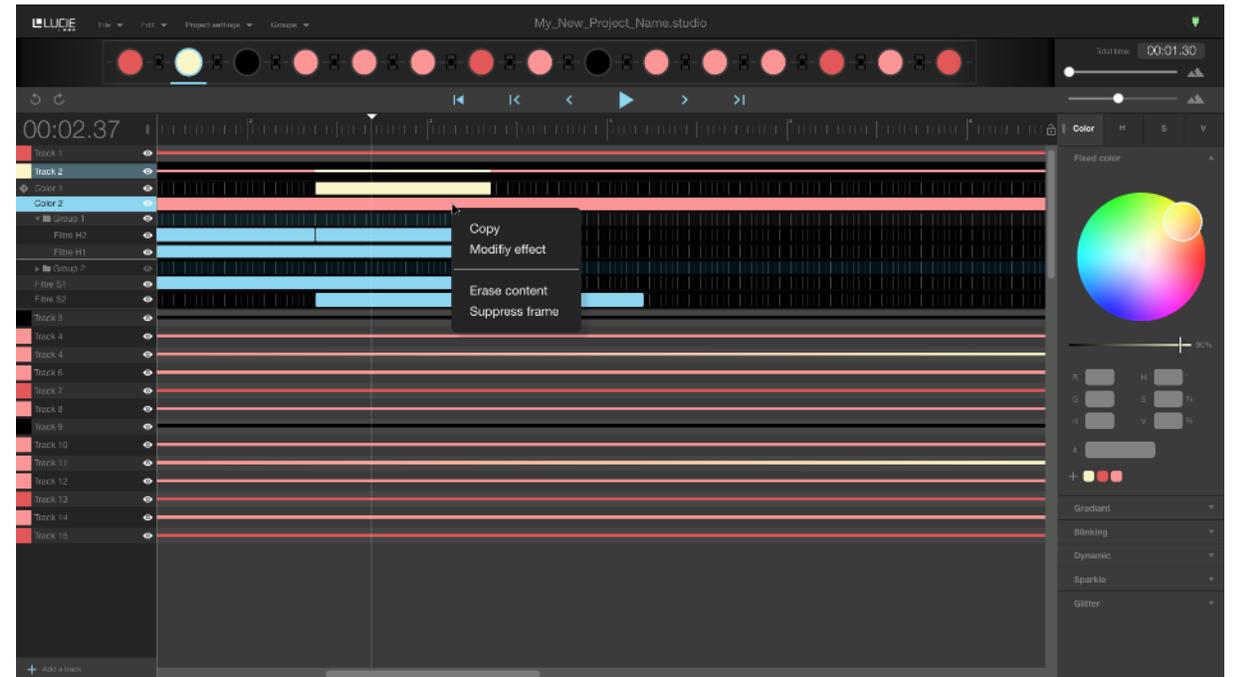
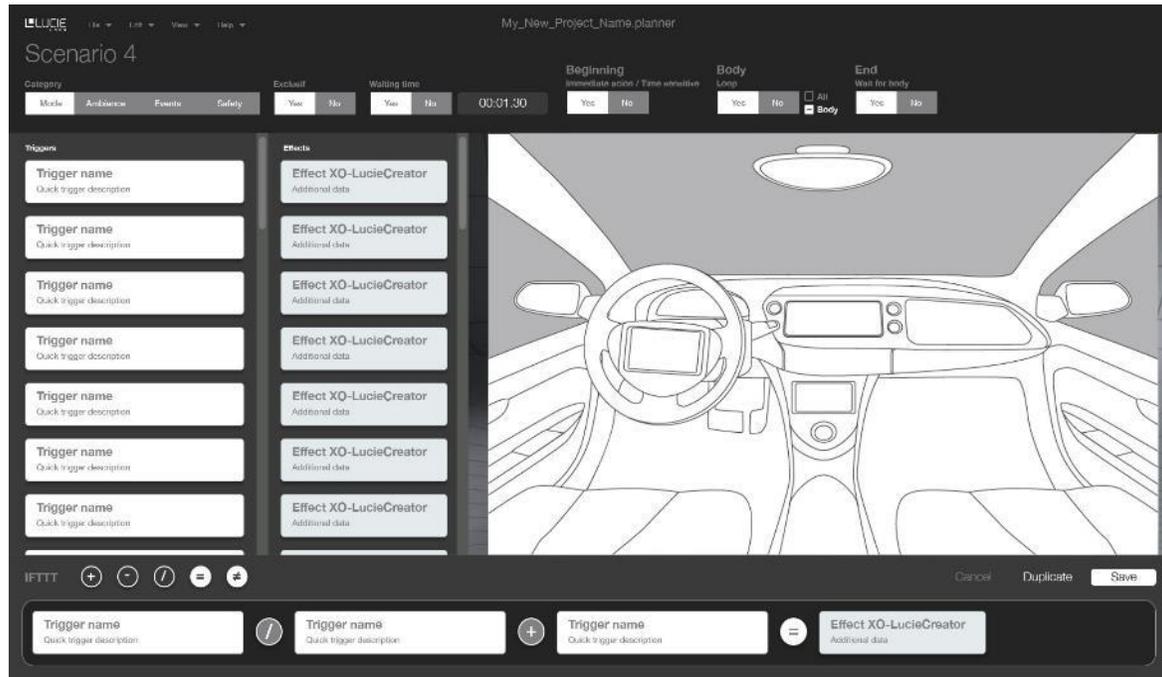
- **ISELED\_ADK**
  - S32K144EVB-Q100 (NXP)
  - ISELED Shield (Inova Semiconductor)
  - LED 'Bar' -16 LEDs (Dominant Opto)
  - €499 Resale
  - Available from Element14/Farnell from April 2018



# ISELED Kit – Software (Lucie Labs Effects S/w)

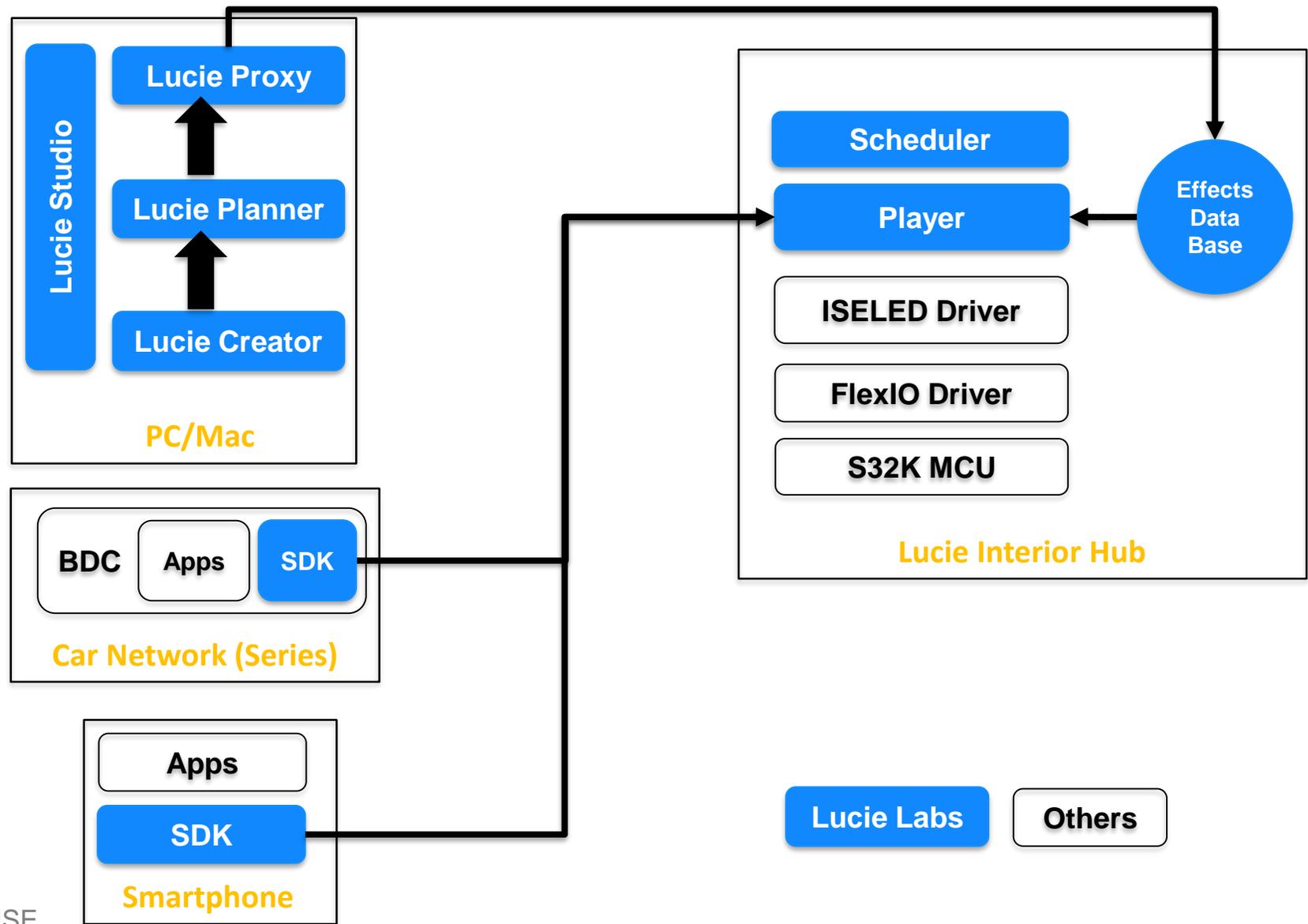
<http://www.lucielabs.com/>

- Free 90-day evaluation license



# ISELED Kit – Software (Lucie Labs Effects S/w)

<http://www.lucielabs.com/>



# ISELED – Benefits

	<b>LIN</b>	<b>ISELED</b>
<i>Lighting streaming</i>	Change of color and brightness (latency = no real time and no streaming)	Real time streaming Up to 25 frames per second, up to 4096 devices
<i>Bus speed</i>	19,6 Kbits/s	2 Mbits/s
<i>Number of supported devices</i>	Max = 15 devices	Max = 4096 devices
<i>Network</i>	Multiple sub network bus needed = cabling complexity	1 bus for the whole vehicle
<i>Command</i>	Unitary + broadcast	
<i>Protocol</i>	Master (gateway) + Slaves	
<i>Calibration (color + brightness)</i>	Assembly line calibration	Chip comes calibrated
<i>Package</i>	ASIC + RGB led	System in package with COB
<i>Cost</i>	\$\$\$	\$

# ISELED – Summary

Feature	Existing LED Drive	ISELED LED Drive
Control and Communication	For changing a parameter in a single LED, all LEDs have to be addressed and updated (shift register approach)	Each Smart LED can be addressed individually. Smart LEDs can be addressed via broadcast or group addresses if required
Calibration of Color and Brightness	Parameter transfer via barcoding Binning classes (grading)	Calibration of Smart LED at the end of LED production, data stored in Smart LED.
Temperature Compensation	SW controlled by Microcontroller	Automatic, self-controlled in Smart LED
Handling	Calibration data for LED need to be stored in Lookup tables and handled by SW in main controller	Automatic calibration by controller in Smart LED
Diagnostics	Very limited via OC error signaling. No identification of affected LED.	Temperature, status and functionality can be accessed for each Smart LED.

# Summary

- ISELED provides the complete ecosystem from LED through to driver and application development
- High density 4096 LEDs
- Cost efficient production logistics – no binning / calibration
- Fast, bi-directional and robust differential communication bus
- Evaluation kit includes ISELED shield, S32K144 MCU EVB & s/w driver, 16 RGB LED bar and Lucie Labs LED effects tool.
- <https://inova-semiconductors.de/products/ISELED.html>

# AUTOMOTIVE NFC STACK



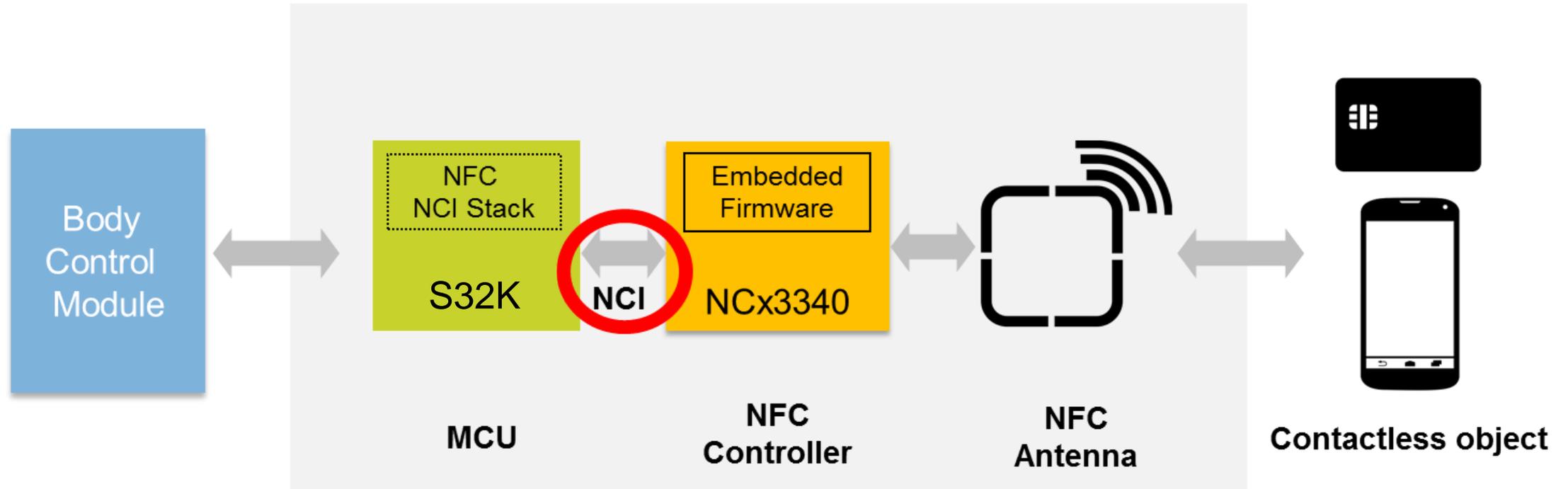
# WHERE DOES NFC FIT IN THE WORLD OF WIRELESS?

	 WiFi	 ZigBee (802.15.4)	 Bluetooth	 NFC
Network topology	 Star	 Mesh	 Point-to-point	 Point-to-point
Range	 30-100 m	 10-20 m	 10 m	 < 0.1 m
Discovery	 Broadcast	 Broadcast	 Broadcast	 Response to field
Power	 High	 Low	 Classic: Mid  LE/Smart: Low	 Tag: Zero  Reader: Very low
Privacy	 Low	 Mid	 Mid	 High

- A major advantage of NFC comes with the **ease of use**. NFC connects automatically in a fraction of a second, so fast it seems **instantaneous**
- NFC consumes **much less power** than Wi-Fi or BT.
- NFC solutions combining **secure elements** are very attractive for **smartphone/smart card** based **car access** and drive **authorization**

# SYSTEM ARCHITECTURE WITH NFC CONTROLLER

FULL NFC FUNCTIONALITY WITHOUT ANY COMPROMISES FOR INTERIOR APPLICATIONS



# Automotive NFC STACK FEATURES

- **Full NFC**

- **Reader/Writer mode:** T1 – T5 for NDEF & legacy format
- **Card Emulation:** T4 (A and B), FeliCa
- **P2P:** LLCP, SNEP
- Tested according to the **NFC Forum Device Test Application**



- **Automotive Quality Package:**

- AUTOSAR, MISRA-C 2012, SPICE
- No open source or 3rd party code
- NXP Automotive Coding Rules
- Code Coverage, Memory usage tests etc.



- **Purchase Model**

- \$0.30 adder per device, orderable as a special part number
- Delivered as SDK m'ware, not pre-programmed in MCU – customer flashes library onto MCU
- Supports S32K144 MCU (512KB). Support for additional S32K families due Q218



# Automotive NFC Stack - PARTS & LICENSING MODEL

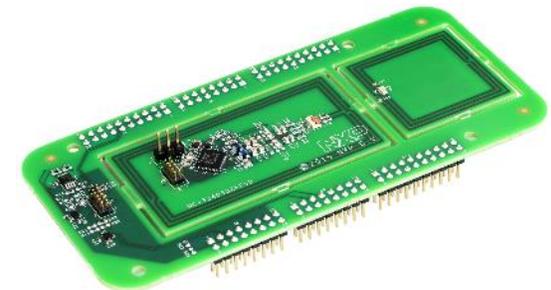
Product	Platform	Partnumber		
MWCT	Autosar	SWCT101XS-ANFC401E	MWCT101xS Autosar 4.0 NFC Stack Evaluation License	<b>Automotive Qi Wireless Charging Transmitter</b>
MWCT	Autosar	SWCT101XS-ANFC401S	MWCT101xS Autosar 4.0 NFC Stack DISM Pack	
MWCT1014	Autosar	MWCT1014SFVLHN	MWCT1014 device with production rights for NFC Stack	
S32K1	Autosar	SW32K14-ANFC401E	S32K14 Autosar 4.0 NFC Stack Evaluation License	<b>32-bit Automotive General Purpose Microcontrollers</b>
S32K1	SDK	SW32K1X-NFC01E	S32K1x NFC Stack Middleware (Binary) Evaluation License	
S32K1	Autosar	SW32K14-ANFC401S	S32K14 Autosar 4.0 NFC Stack DISM Pack	
S32K1	SDK	SW32K1X-NFC01S	S32K1x NFC Stack Middleware (Binary) DISM Pack	
S32K144	Both Autosar and SDK	2 new PN TBC - one in 100LQFP and one in 64LQFP	S32K144 device with production rights for NFC Stack	

License	Price	Duration
Evaluation (binary)	Free	90 Days
Production (binary)	\$0.30/device	Perpetual
Development Support (DISM)	\$6K/p.a.	12 Months



# AVAILABILITY

- Go to [www.nxp.com/S32K](http://www.nxp.com/S32K)
  1. Order **S32K144EVB-Q100**
  2. Order **NCX3340S32KEVB**
    - Available from nxp.com soon. For urgent opportunities contact [marc.manninger@nxp.com](mailto:marc.manninger@nxp.com)
  3. Download **ANFC NCI Stack**
    - See 'Software & Tools' Tab



# 3<sup>RD</sup> PARTY TOOLS



## Functional Safety Version of IAR Embedded Workbench for ARM V7.40.6

- Certified for each ASIL A-D of ISO 26262 without further tool qualification
- The Same Version has been tested and validated for MCAL compliance
- Guaranteed support through the product life cycle: Prioritized support, Validated service packs, Regular reports of known problems

### • IAR Visual State

- Set of tools for designing, testing and implementing embedded applications based on state machines.
- Based on Unified Modeling Language (UML) state machine subset
- Generates very compact C/C++ code, 100% consistent with your design
- Advanced verification and validation tools

### • Static Analysis: C-STAT

- Checks compliance with; MISRA C:2012, MISRA C++:2008, MISRA C:2004, CWE and CERT C/C++
- Extensive and detailed documentation. Fully integrated with IAR Embedded Workbench

### • Dynamic Analysis: C-RUN

- C-RUN can perform following errors check; Heap and memory leaks checking, Bounds checking, Integer conversion failure, Shift overflow, Division by zero
- Minimized test code overhead and speed penalty. Full Integration with IAR Embedded Workbench



# S32K – Keil Tools

[www.keil.com/NXP](http://www.keil.com/NXP)

- **ARM Compiler 6 (LLVM based) now TUV certified**
- **Keil MDK-Lite™**
  - Free eval version that limits code size to 32KB. Nearly all examples will compile within 32KB limit.
- **S32K144EVB: hands-on lab using μVision** [http://www.keil.com/appnotes/docs/apnt\\_299.asp](http://www.keil.com/appnotes/docs/apnt_299.asp)
  - Blinky example uses potentiometer to control the tri-color LED via the Keil RTX5 RTOS included with MDK-ARM installation. The DSP Sine example demonstrates waveform analysis using the Logic Analyzer
- **S32K148EVB: ETM Instruction Trace using ARM Keil MDK 5 Toolkit**
  - [www.keil.com/appnotes/docs/apnt\\_305.asp](http://www.keil.com/appnotes/docs/apnt_305.asp)
  - Introduces ETM Instruction Trace on K148 MCU using MDK toolkit with μVision® IDE & ULINK™pro debug adapter
    - **Code Coverage:** were all the assembly instructions executed ? This data can be saved as a .gcv report.
    - **Performance Analysis:** where the processor spent its time displayed in graphical and numerical formats.
    - **Execution Profiling:** How long instructions, ranges of instructions, functions or C source code took in both time and CPU cycles as well as number of times these were executed. - Code Coverage, Performance Analysis and Execution Profiling
- **NXP Cookbook Example Ports for MDK** [www.keil.com/appnotes/docs/apnt\\_304.asp](http://www.keil.com/appnotes/docs/apnt_304.asp)



# S32K On NXP Distributor Extranet

- <https://nxp1.sharepoint.com/team/s/ext96/SitePages/Home%20FSL-NXP.aspx>

- Distributor Extranet: contains Distributor specific / non public product information – ppts (Marketing & Technical), NDA data sheets, competitive information, launch calendars etc

- See '32-bit Arm' tab

- 'S32K1'

- S32K Overview ppt
- S32K Hands-on training .ppt
- Etc.

**NXP** Distribution Extranet EDIT LINKS  
Distributor Extranet

Home  
Documents NXP  
Automotive  
Automotive MCU  
Advanced Analog  
Sensors  
Security & Connectivity  
Microcontrollers and Processors  
MIFARE, NFC and

Welcome to the Distributor Extranet, a resource for DFAEs.

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Automotive MCU  
Sensors  
Advanced Analog

**SECURITY & CONNECTIVITY**  
Microcontrollers and Processors (Kinetis, LPC, i.MX)  
Secure Interfaces & Power (Si&P)

**Distribution Technical Resource Managers**  
Folders  
- DFAE OnBoarding

Distribution Extranet EDIT LINKS  
Automotive MCU Home Page

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Learn More >>

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We hope you find it useful. Please send us your feedback at: [jesse.garcia1@nxp.com](mailto:jesse.garcia1@nxp.com)

**General Information**  
AMP Distribution General Presentation  
AMP Distribution Contact List  
AMP Product Launch Calendar  
AMP Distribution Price List (Current and NPI)

**Featured Resources**  
AMP Public Website  
AMP Product Update Report (PUR)  
DFAE Training

**Product Information**  
8-bit S08 16-bit S12(X) 16-bit S12 MagniV **32-bit Arm** 32-bit Power Architecture General Info

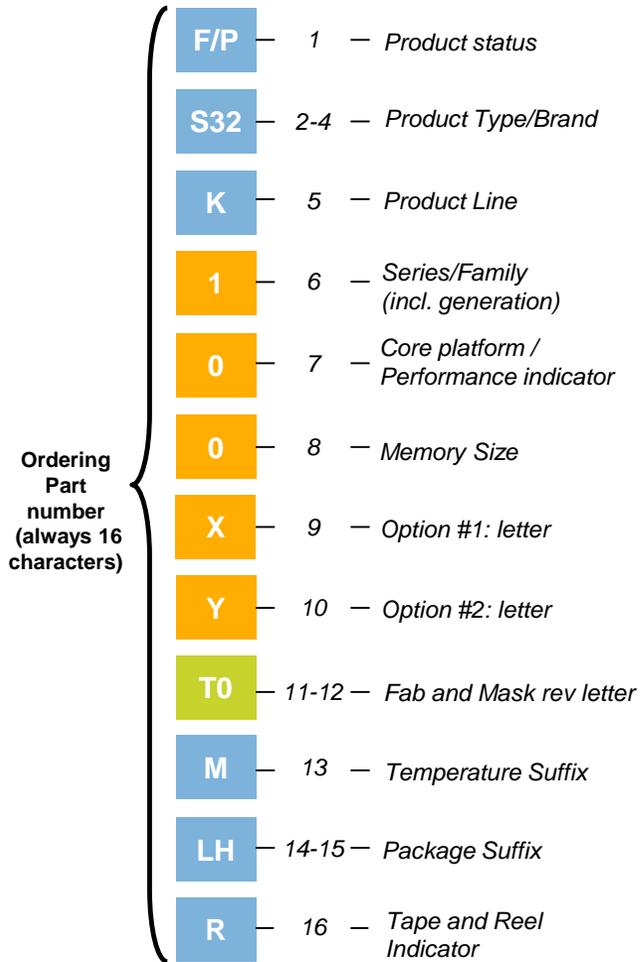
- BlueBox
- GreenBox
- KEA
- S32K1**
- S32V234
- MAC57D5XX





SECURE CONNECTIONS  
FOR A SMARTER WORLD

# S32K1xx Part Number Nomenclature



**1<sup>st</sup> Character**  
*Product Status for ordering and marking*  
**P** for prototype and  
**F** for qualified ordering P/N

**2<sup>nd</sup>, 3<sup>rd</sup> & 4<sup>th</sup> Character**  
*Product Type / Brand*  
**S32** for Automotive 32Bit MCU

**5<sup>th</sup> Character**  
*Product Line*  
**K** = ARM Cortex MCUs

**6<sup>th</sup> Character**  
*Series / Family*  
**1** = 1<sup>st</sup> product family

**7<sup>th</sup> Character**  
*Core platform / Performance indicator*  
**1** = M0+  
**4** = M4F

**8<sup>th</sup> Character**  
*Product/Memory*

	2	4	6	8
<b>S32K11x</b>	-	-	128k	256k
<b>S32K14x</b>	256k	512k	1M	2M

**9<sup>th</sup> & 10<sup>th</sup> Characters**  
*Ordering options*

**X:** Speed  
**B** = 48 MHz without DMA (S32K11x only)  
**L** = 48 MHz with DMA (S32K11x only)  
**H** = 80 MHz  
**W** = 80MHz, Grade 0 version only  
**U**<sup>1</sup> = 112 MHz (not valid with **M** temperature)

**Y:** Optional feature  
**R**=Base feature set  
**V**=Base feature set with NFC Stack license  
**F**=CAN FD, FlexIO  
**A**<sup>1</sup>=CAN FD, FlexIO, Security  
**X**<sup>1</sup>=CAN FD, FlexIO, Security with NFC Stack License  
**E**=Ethernet, Serial Audio Interface (S32K148 only)  
**J**<sup>1</sup>=Ethernet, Serial Audio Interface, CAN FD, FlexIO, Security (S32K148 only)  
**I**=ISELED, FlexIO  
**L**<sup>1</sup>= ISELED, CAN FD, FlexIO, Security  
**G**<sup>1</sup>=ISELE, Ethernet, Serial Audio Interface, CAN FD, FlexIO, Security (S32K148 only)

**11<sup>th</sup> & 12<sup>th</sup> Character**  
*Fab and Mask rev*  
**Tx** = Globalfoundries  
**x0** = 1<sup>st</sup> fab revision

**13<sup>th</sup> Character**  
*Temperature*  
**V** = -40°C to 105°C  
**M** = -40°C to 125°C  
**W** = -40°C to 150°C

**14<sup>th</sup> & 15<sup>th</sup> Character**  
*Package Suffix*

pins	LQFP	QFN	BGA
<b>32</b>	-	FM	-
<b>48</b>	LF	-	-
<b>64</b>	LH	-	-
<b>100</b>	LL	-	MH
<b>144</b>	LQ	-	-
<b>176</b>	LU	-	-

**16<sup>th</sup> Character**  
*Tape & Reel*  
**T** = Trays/Tubes  
**R** = Tape & Reel

**Note:**  
1. Write or erase access to security (CSEc) or EEPROM is allowed only when device operating in RUN mode (up to 80MHz). No write or erase access to security and EEPROM allowed when device running at HSRUN mode (112MHz).  
2. Not all part number combinations are available. See [S32K1xx\\_Orderable\\_Part\\_Number\\_List.xlsx](#) with the Datasheet (Rev7. and beyond) for a list of standard orderable part numbers.

3. Part numbers no longer offered as standard include:  
Ordering Option X (M:64MHz); Ordering Option Y (N: limited RAM. 16KB for K142, 48KB for K144, 96KB for K146, 192KB for K148 S: Security B:CAN FD, Flex IO, limited RAM (K14x only). C: CAN FD, FlexIO, Security, limited RAM (K14x only)); Temperature (C: -40C to 85C)